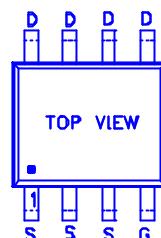
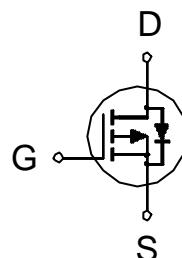


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
-30	35m	-8A



4 : GATE
5,6,7,8 : DRAIN
1,2,3 : SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-8	A
		-7	
Pulsed Drain Current ¹	I_{DM}	-30	
Power Dissipation	P_D	2.5	W
		1.3	
Operating Junction & Storage Temperature Range	T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		25	°C / W
Junction-to-Ambient	$R_{\theta JA}$		50	°C / W

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

ELECTRICAL CHARACTERISTICS ($T_c = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-30			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.8	-1.5	-2.5	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -20V, V_{GS} = 0V, T_j = 125^\circ\text{C}$			-10	
On-State Drain Current ¹	$I_{D(\text{ON})}$	$V_{DS} = -5V, V_{GS} = -10V$	-30			A
Drain-Source On-State Resistance ¹	$R_{DS(\text{ON})}$	$V_{GS} = -4.5V, I_D = -6A$		44	60	m
		$V_{GS} = -10V, I_D = -8A$		28	35	
Forward Transconductance ¹	g_{fs}	$V_{DS} = -10V, I_D = -6A$		7		S

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DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = -10V, f = 1MHz$	970			pF
Output Capacitance	C_{oss}		370			
Reverse Transfer Capacitance	C_{rss}		180			
Total Gate Charge ²	Q_g	$V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = -10V, I_D = -8A$	28			nC
Gate-Source Charge ²	Q_{gs}		6			
Gate-Drain Charge ²	Q_{gd}		12			
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = -15V, R_L = 1$	20			nS
Rise Time ²	t_r		17			
Turn-Off Delay Time ²	$t_{d(off)}$		180			
Fall Time ²	t_f		75			
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25^{\circ}\text{C}$)						
Continuous Current	I_s				-3	A
Pulsed Current ³	I_{SM}				-6	
Forward Voltage ¹	V_{SD}	$I_F = -1A, V_{GS} = 0V$			-1	V
Reverse Recovery Charge	Q_{rr}			7.9		nC

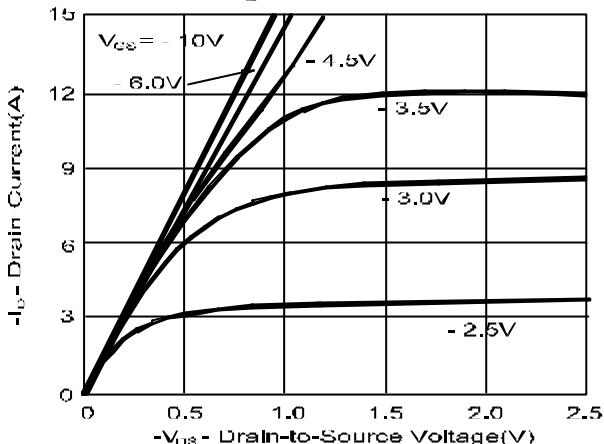
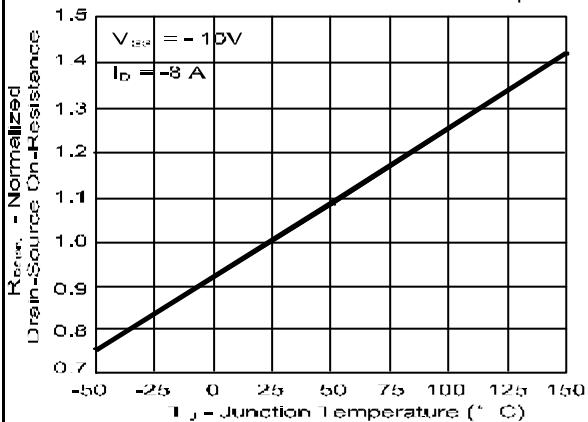
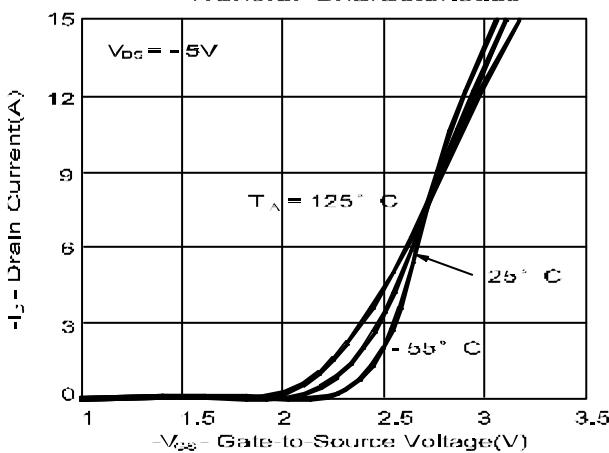
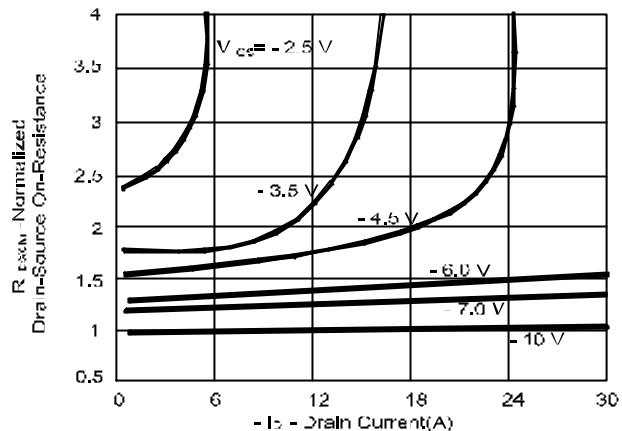
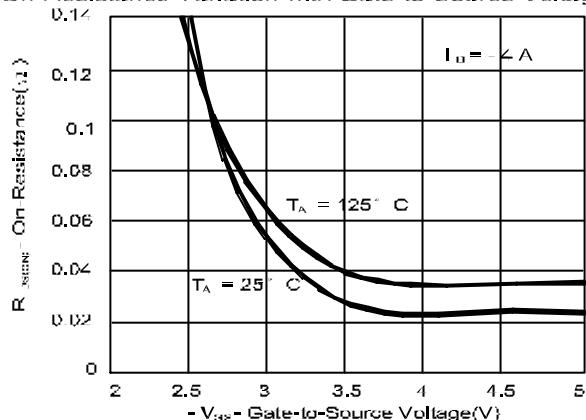
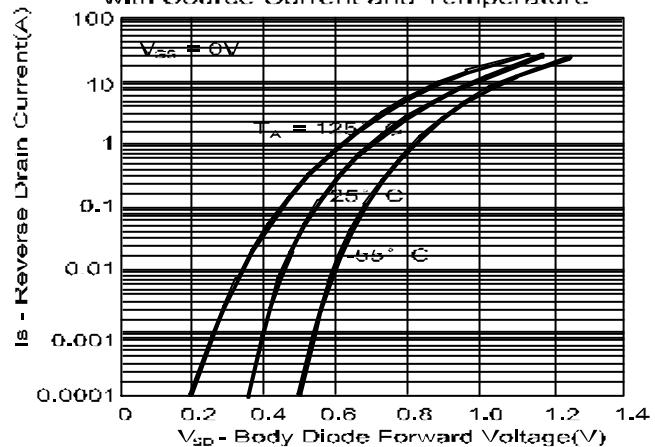
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.³Pulse width limited by maximum junction temperature.**REMARK: THE PRODUCT MARKED WITH “P3503EVG”, DATE CODE or LOT #**

Orders for parts with Lead-Free plating can be placed using the PXXXXXXG parts name.

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On-Region Characteristics**On-Resistance Variation with Temperature****Transfer Characteristics****On-Resistance Variation with Drain Current and Gate Voltage****On-Resistance Variation with Gate-to-Source Voltage****Body Diode Forward Voltage Variation with Source Current and Temperature**

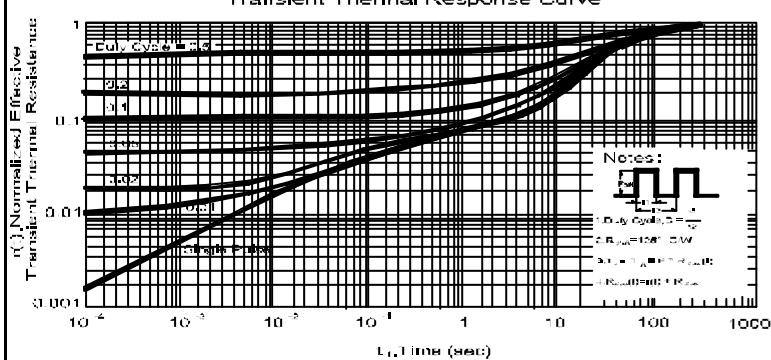
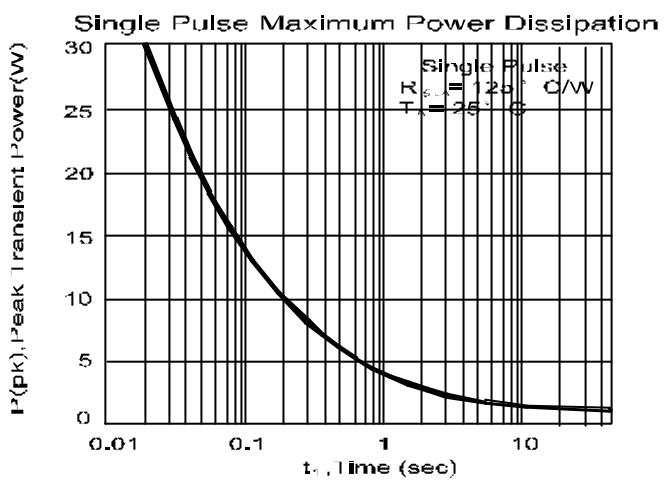
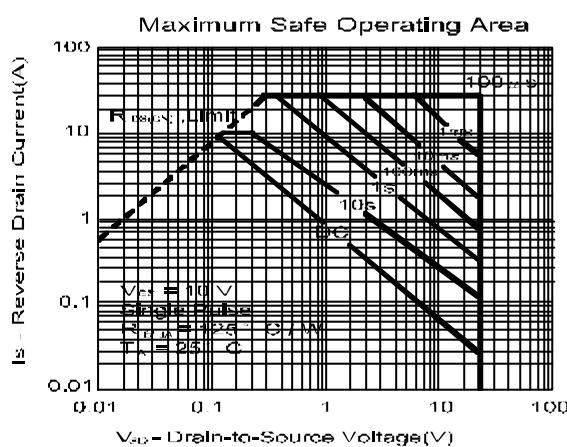
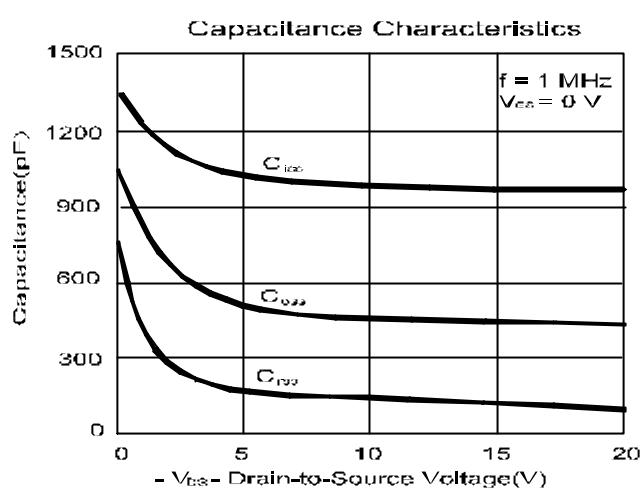
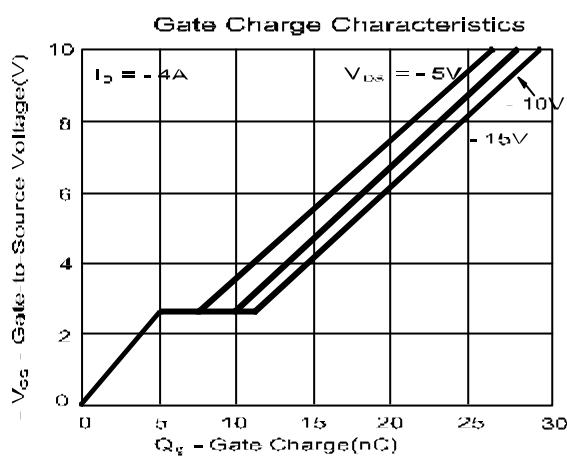
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SOIC-8(D) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.5	0.715	0.83
B	3.8	3.9	4.0	I	0.18	0.254	0.25
C	5.8	6.0	6.2	J		0.22	
D	0.38	0.445	0.51	K	0°	4°	8°
E		1.27		L			
F	1.35	1.55	1.75	M			
G	0.1	0.175	0.25	N			

